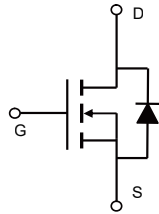


## Description

|                                                                                                                                                                                                                                                                                                                                                                                                   |                                                                                                                                                                                                                             |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>Features</b> <ul style="list-style-type: none"> <li>● 30V, 20A</li> <li>● <math>R_{DS(ON)} &lt; 6m\Omega</math> @ <math>V_{GS} = 10V</math></li> <li>● <math>R_{DS(ON)} &lt; 8.6m\Omega</math> @ <math>V_{GS} = 4.5V</math></li> <li>● Advanced Trench Technology</li> <li>● Provide Excellent <math>R_{DS(ON)}</math> and Low Gate Charge</li> <li>● Lead free product is acquired</li> </ul> | <b>Application</b> <ul style="list-style-type: none"> <li>● Load Switch</li> <li>● PWM Application</li> <li>● Power management</li> </ul> <p><i>100% UIS TESTED!</i><br/><i>100% <math>\Delta V_{ds}</math> TESTED!</i></p> |
|  <p>SOP-8</p>                                                                                                                                                                                                                                                                                                    |  <p>Schematic</p>                                                                                                                        |

## Package Marking and Ordering Information

| Device Marking | Device      | OUTLINE | Device Package | Reel Size | Reel (PCS) | Per Carton (PCS) |
|----------------|-------------|---------|----------------|-----------|------------|------------------|
| VSM20N03       | VSM20N03-S8 | TAPING  | SOP-8          | 13inch    | 4000       | 48000            |

## Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$ unless otherwise specified)

| Symbol                            | Parameter                                       |                        | Max.        | Units |
|-----------------------------------|-------------------------------------------------|------------------------|-------------|-------|
| V <sub>DSS</sub>                  | Drain-Source Voltage                            |                        | 30          | V     |
| V <sub>GSS</sub>                  | Gate-Source Voltage                             |                        | ±20         | V     |
| I <sub>D</sub>                    | Continuous Drain Current                        | T <sub>A</sub> = 25°C  | 20          | A     |
|                                   |                                                 | T <sub>A</sub> = 100°C | 13          | A     |
| I <sub>DM</sub>                   | Pulsed Drain Current <sup>note1</sup>           |                        | 80          | A     |
| E <sub>AS</sub>                   | Single Pulsed Avalanche Energy <sup>note2</sup> |                        | 100         | mJ    |
| P <sub>D</sub>                    | Power Dissipation                               | T <sub>A</sub> = 25°C  | 4           | W     |
| R <sub>θJA</sub>                  | Thermal Resistance, Junction to Ambient         |                        | 31.3        | °C/W  |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Temperature Range         |                        | -55 to +150 | °C    |

## Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise specified)

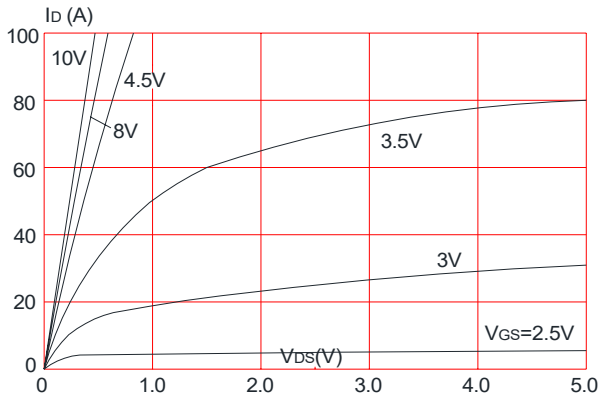
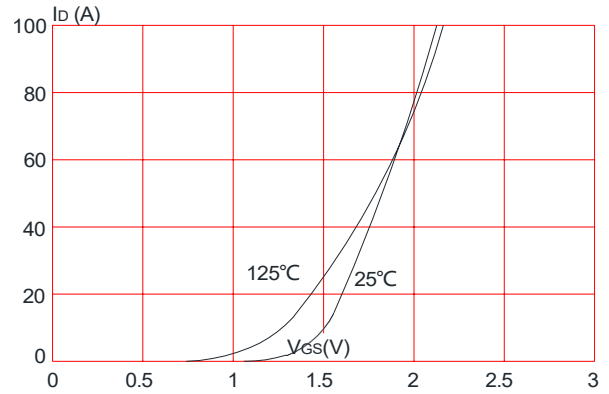
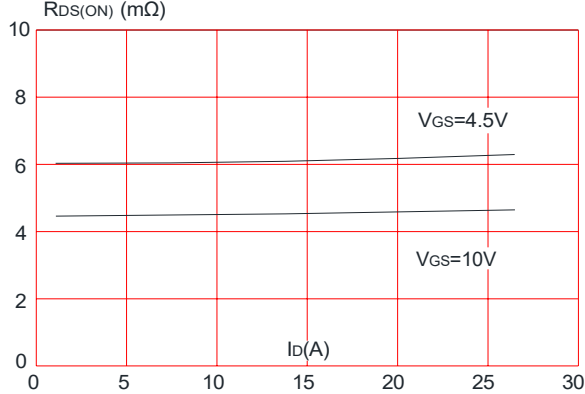
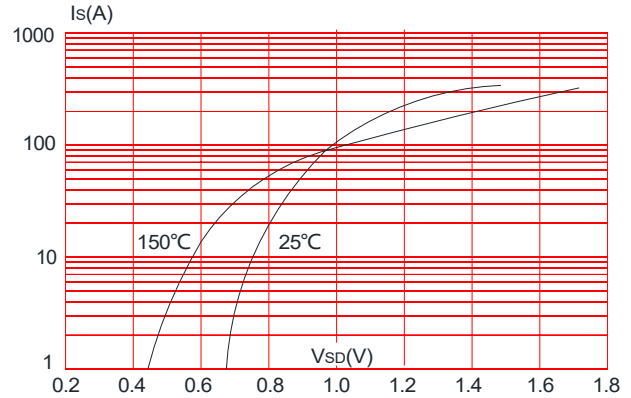
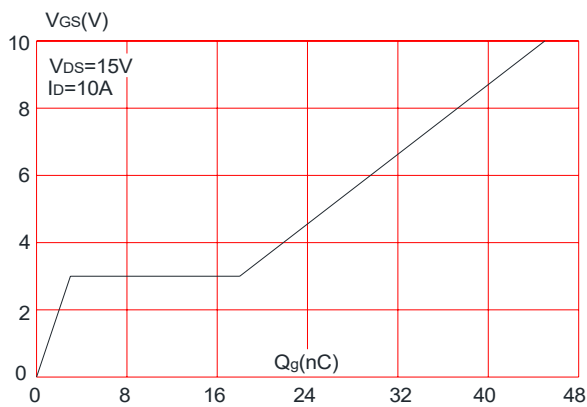
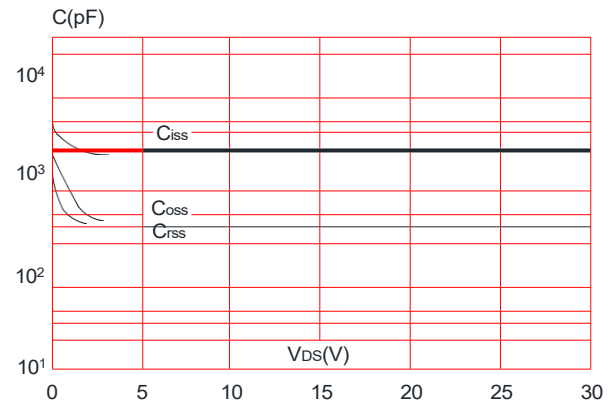
| Symbol                                                 | Parameter                                                 | Test Condition                                                                              | Min. | Typ. | Max. | Units |
|--------------------------------------------------------|-----------------------------------------------------------|---------------------------------------------------------------------------------------------|------|------|------|-------|
| Off Characteristic                                     |                                                           |                                                                                             |      |      |      |       |
| V <sub>(BR)DSS</sub>                                   | Drain-Source Breakdown Voltage                            | V <sub>GS</sub> =0V, I <sub>D</sub> =250μA                                                  | 30   | -    | -    | V     |
| I <sub>DSS</sub>                                       | Zero Gate Voltage Drain Current                           | V <sub>DS</sub> =30V, V <sub>GS</sub> =0V,                                                  | -    | -    | 1.0  | μA    |
| I <sub>GSS</sub>                                       | Gate to Body Leakage Current                              | V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V                                                  | -    | -    | ±100 | nA    |
| On Characteristics                                     |                                                           |                                                                                             |      |      |      |       |
| V <sub>GS(th)</sub>                                    | Gate Threshold Voltage                                    | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA                                    | 0.7  | 1.0  | 1.5  | V     |
| R <sub>DS(on)</sub>                                    | Static Drain-Source on-Resistance<br><small>note3</small> | V <sub>GS</sub> =10V, I <sub>D</sub> =20A                                                   | -    | 4.6  | 6    | mΩ    |
|                                                        |                                                           | V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A                                                  | -    | 6.1  | 8.6  |       |
| Dynamic Characteristics                                |                                                           |                                                                                             |      |      |      |       |
| C <sub>iss</sub>                                       | Input Capacitance                                         | V <sub>DS</sub> =15V, V <sub>GS</sub> =0V,<br>f=1.0MHz                                      | 1214 | 1700 | 2295 | pF    |
| C <sub>oss</sub>                                       | Output Capacitance                                        |                                                                                             | 229  | 320  | 432  | pF    |
| C <sub>rss</sub>                                       | Reverse Transfer Capacitance                              |                                                                                             | 214  | 300  | 405  | pF    |
| Q <sub>g</sub>                                         | Total Gate Charge                                         | V <sub>DS</sub> =15V, I <sub>D</sub> =10A,<br>V <sub>GS</sub> =10V                          | 32   | 45   | 60.8 | nC    |
| Q <sub>gs</sub>                                        | Gate-Source Charge                                        |                                                                                             | -    | 3    | -    | nC    |
| Q <sub>gd</sub>                                        | Gate-Drain(“Miller”) Charge                               |                                                                                             | 11   | 15   | 20   | nC    |
| Switching Characteristics                              |                                                           |                                                                                             |      |      |      |       |
| t <sub>d(on)</sub>                                     | Turn-on Delay Time                                        | V <sub>DS</sub> =15V,<br>I <sub>D</sub> =20A, R <sub>GEN</sub> =3Ω,<br>V <sub>GS</sub> =10V | -    | 21   | -    | ns    |
| t <sub>r</sub>                                         | Turn-on Rise Time                                         |                                                                                             | -    | 32   | -    | ns    |
| t <sub>d(off)</sub>                                    | Turn-off Delay Time                                       |                                                                                             | -    | 59   | -    | ns    |
| t <sub>f</sub>                                         | Turn-off Fall Time                                        |                                                                                             | -    | 34   | -    | ns    |
| Drain-Source Diode Characteristics and Maximum Ratings |                                                           |                                                                                             |      |      |      |       |
| I <sub>S</sub>                                         | Maximum Continuous Drain to Source Diode Forward Current  |                                                                                             | -    | -    | 20   | A     |
| I <sub>SM</sub>                                        | Maximum Pulsed Drain to Source Diode Forward Current      |                                                                                             | -    | -    | 80   | A     |
| V <sub>SD</sub>                                        | Drain to Source Diode Forward Voltage                     | V <sub>GS</sub> =0V, I <sub>S</sub> =20A                                                    | -    | -    | 1.2  | V     |
| t <sub>rr</sub>                                        | Body Diode Reverse Recovery Time                          | I <sub>F</sub> =20A, dI/dt=100A/μs                                                          | -    | 15   | -    | ns    |
| Q <sub>rr</sub>                                        | Body Diode Reverse Recovery Charge                        |                                                                                             | -    | 4    | -    | nC    |

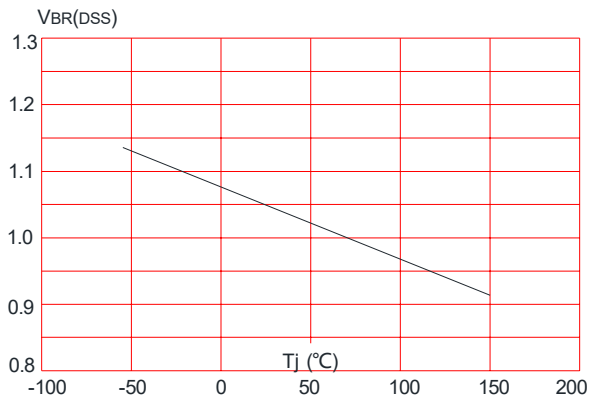
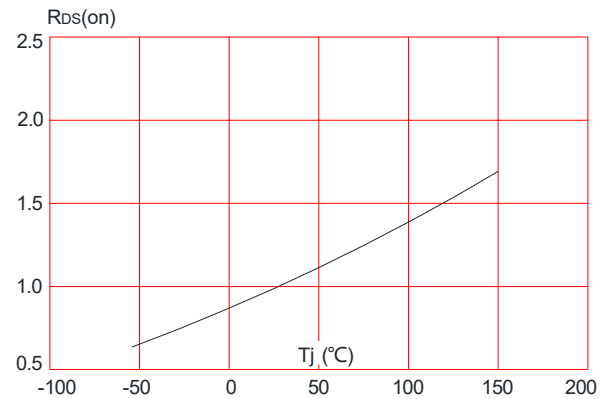
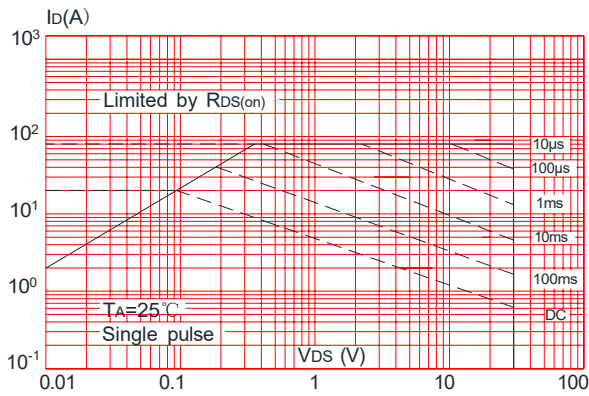
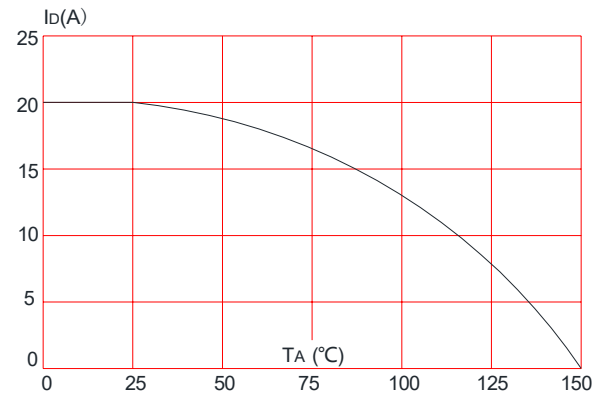
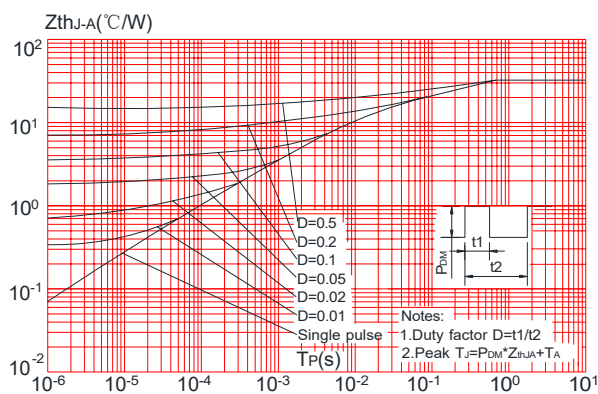
Notes: 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. EAS condition: T<sub>J</sub>=25°C, V<sub>GS</sub>=15V, R<sub>G</sub>=25Ω, L=0.5mH, I<sub>AS</sub>=20A

3. Pulse Test: Pulse Width≤300μs, Duty Cycle≤0.5%

## Typical Performance Characteristics

**Figure1: Output Characteristics**

**Figure 2: Typical Transfer Characteristics**

**Figure 3: On-resistance vs. Drain Current**

**Figure 4: Body Diode Characteristics**

**Figure 5: Gate Charge Characteristics**

**Figure 6: Capacitance Characteristics**


**Figure 7: Normalized Breakdown Voltage vs. Junction Temperature**

**Figure 8: Normalized on Resistance vs. Junction Temperature**

**Figure 9: Maximum Safe Operating Area**

**Figure 10: Maximum Continuous Drain Current vs. Ambient Temperature**

**Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Ambient**


## Test Circuit

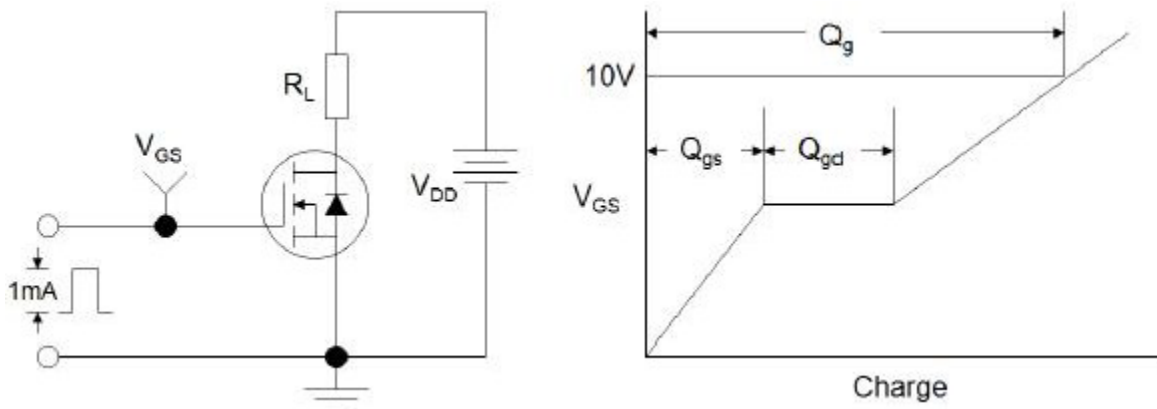


Figure1:Gate Charge Test Circuit & Waveform

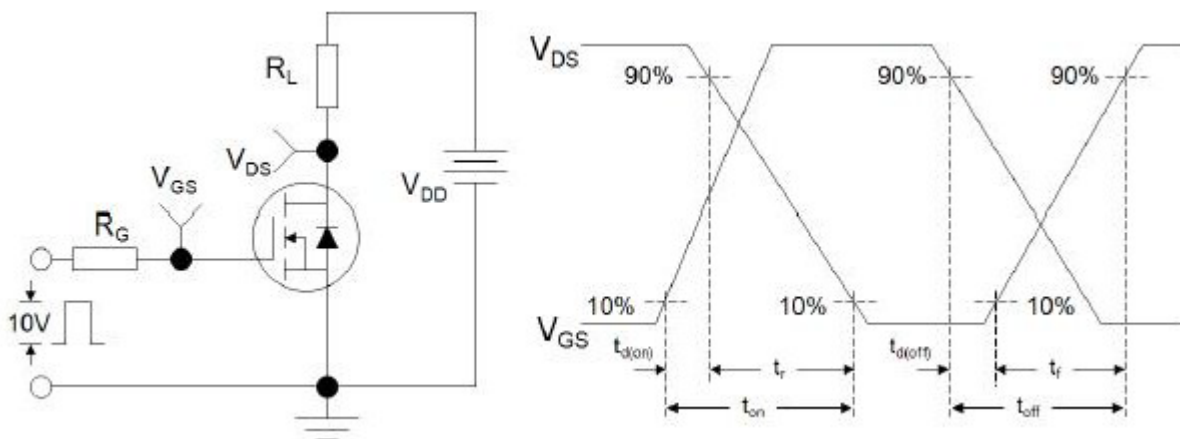


Figure 2: Resistive Switching Test Circuit & Waveforms

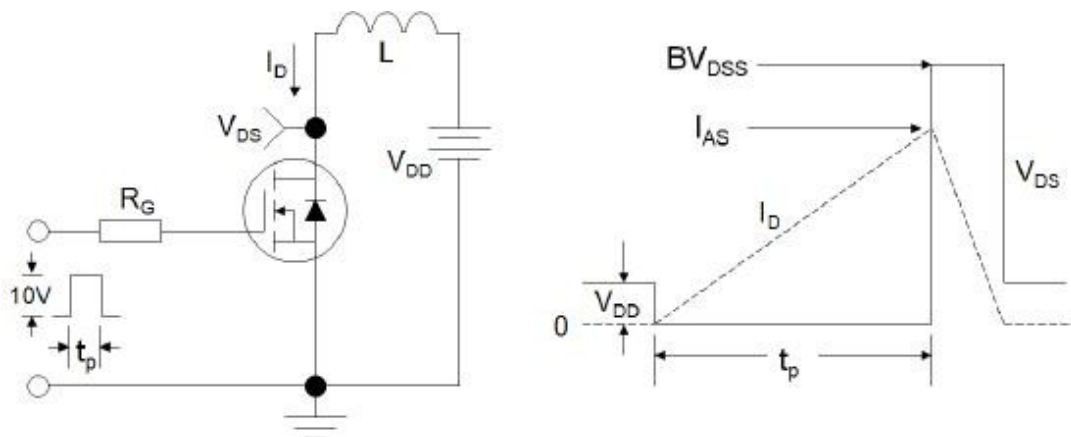


Figure 3:Unclamped Inductive Switching Test Circuit & Waveforms